



# Ultra High Performance BGA Cooling Solutions w/ maxiGRIP™ Attachment

**ATS PART # ATS-50300B-C2-R0**

## Features & Benefits

- » maxiFLOW™ design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- » maxiGRIP™ attachment applies steady, even pressure to the component and does not require holes in the PCB
- » Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock and Unpackaged Drop Testing standards
- » Comes preassembled with high performance, phase changing, thermal interface material
- » Designed for standard height components from 3 to 4.5mm



*\*Image above is for illustration purposes only.*

## Thermal Performance

### AIR VELOCITY

FT/MIN

M/S

### THERMAL RESISTANCE

°C/W (UNDUCTED FLOW)

°C/W (DUCTED FLOW)

200

1.0

7.1

5.4

300

1.5

5.7

400

2.0

4.9

500

2.5

4.4

600

3.0

4

700

3.5

3.7

800

4.0

3.4

## Product Details

DIMENSION A

DIMENSION B

DIMENSION C

DIMENSION D

INTERFACE MATERIAL

FINISH

30 mm

30 mm

7.5 mm

43.2 mm

SAINT-GOBAIN C1100F

BLUE-ANODIZED

### NOTES:

- 1) Dimension C = heat sink height from bottom of the base to the top of the fin field.
- 2) ATS-50300B-C1-R0 is a substitute item available utilizing an equivalent phase change material (Chomerics T766).
- 3) Thermal performance data are provided for reference only. Actual performance may vary by application.
- 4) ATS reserves the right to update or change its products without notice to improve the design or performance.
- 5) Optional maxiGRIP™ Installation/Removal Tool Set P/N: MGT300
- 6) Contact ATS to learn about custom options available.



**ATS** ADVANCED  
THERMAL  
SOLUTIONS, INC.  
Innovations in Thermal Management®

**For more information, to find a distributor or to place an order, visit [www.qats.com](http://www.qats.com) or call: 781.769.2800 (North America); +31 (0) 3569 84715 (Europe).**